

AO5600E
Complementary Enhancement Mode Field Effect Transistor
General Description

The AO5600E/L uses advanced trench technology MOSFETs to provide excellent $R_{DS(ON)}$ and low gate charge. The complementary MOSFETs may be used in H-bridge, Inverters and other applications. AO5600E and AO5600EL are electrically identical.

- RoHS compliant
- AO5600EL is Halogen Free

ESD PROTECTED!

Features
n-channel

V_{DS} (V) = 20V, I_D = 0.6A (V_{GS} =4.5V)

$R_{DS(ON)} < 0.65\Omega$ (V_{GS} = 4.5V)

$R_{DS(ON)} < 0.75\Omega$ (V_{GS} = 2.5V)

$R_{DS(ON)} < 0.95\Omega$ (V_{GS} = 1.8V)

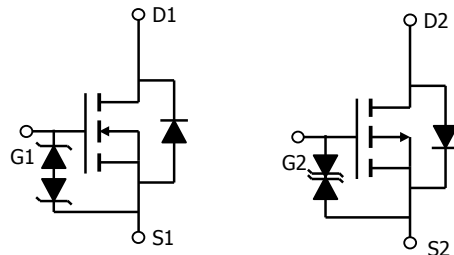
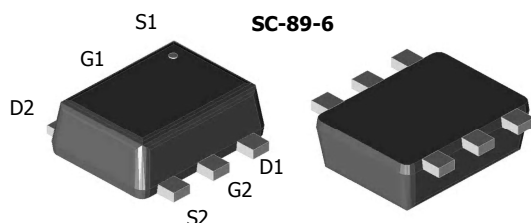
p-channel

V_{DS} (V) = -20V, I_D = -0.5A (V_{GS} =-4.5V)

$R_{DS(ON)} < 0.8\Omega$ (V_{GS} = -4.5V)

$R_{DS(ON)} < 1.0\Omega$ (V_{GS} = -2.5V)

$R_{DS(ON)} < 1.3\Omega$ (V_{GS} = -1.8V)


Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Max n-channel	Max p-channel	Units
Drain-Source Voltage	V_{DS}	20	-20	V
Gate-Source Voltage	V_{GS}	± 8		V
Continuous Drain Current ^{B,H}	$T_C=25^\circ\text{C}$	0.6	-0.5	A
	$T_C=100^\circ\text{C}$	0.4	-0.38	
Pulsed Drain Current ^B	I_{DM}	3	-1	
Power Dissipation	$T_C=25^\circ\text{C}$	0.38	0.38	W
	$T_C=100^\circ\text{C}$	0.24	0.24	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150		$^\circ\text{C}$

Thermal Characteristics: n-channel and p-channel

Parameter		Symbol	Device	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$t \leq 10\text{s}$	$R_{\theta JA}$	n-ch	275	330	$^\circ\text{C/W}$
Maximum Junction-to-Ambient ^A	Steady-State		n-ch	360	450	$^\circ\text{C/W}$
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	n-ch	300	350	$^\circ\text{C/W}$
Maximum Junction-to-Ambient ^A	$t \leq 10\text{s}$	$R_{\theta JA}$	p-ch	275	330	$^\circ\text{C/W}$
Maximum Junction-to-Ambient ^A	Steady-State		p-ch	360	450	$^\circ\text{C/W}$
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	p-ch	300	350	$^\circ\text{C/W}$

N-channel Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =20V, V _{GS} =0V T _J =55°C			1 5	μA
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±4.5V V _{DS} =0V, V _{GS} =±8V			±1 ±100	μA μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} I _D =250μA	0.45	0.6	1	V
I _{D(ON)}	On state drain current	V _{GS} =4.5V, V _{DS} =5V	3			A
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =4.5V, I _D =0.5A T _J =125°C		0.54 0.81	0.65 1	Ω
		V _{GS} =2.5V, I _D =0.5A		0.63	0.75	
		V _{GS} =1.8V, I _D =0.3A		0.73	0.95	Ω
		g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =0.5A		1.5
V _{SD}	Diode Forward Voltage	I _S =0.1A,V _{GS} =0V		0.65	1	V
I _S	Maximum Body-Diode Continuous Current				0.4	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =10V, f=1MHz		35	45	pF
C _{oss}	Output Capacitance			8		pF
C _{rss}	Reverse Transfer Capacitance			6		pF
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =10V, I _D =0.5A		0.63	1	nC
Q _{gs}	Gate Source Charge			0.08		nC
Q _{gd}	Gate Drain Charge			0.16		nC
t _{D(on)}	Turn-On DelayTime	V _{GS} =5V, V _{DS} =10V, R _L =50Ω, R _{GEN} =3Ω		4.5		ns
t _r	Turn-On Rise Time			3.3		ns
t _{D(off)}	Turn-Off DelayTime			70		ns
t _f	Turn-Off Fall Time			35		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =0.5A, dI/dt=100A/μs		8	10	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =0.5A, dI/dt=100A/μs		2		nC

A: The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C: The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient.

D: The static characteristics in Figures 1 to 6,12,14 are obtained using <300 μs pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The SOA curve provides a single pulse rating.

F: The maximum current rating is limited by bond-wires

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N-Channel TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

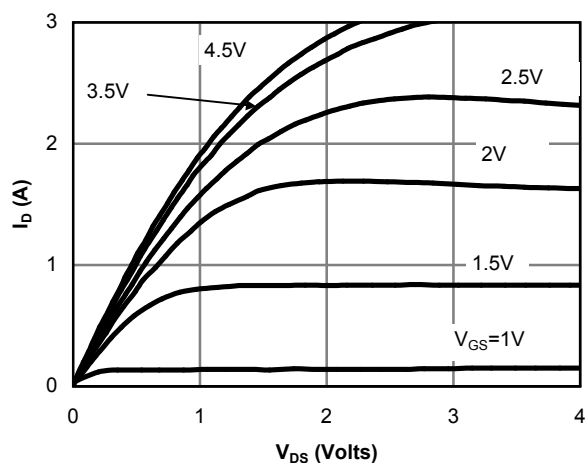


Figure 1: On-Region Characteristics

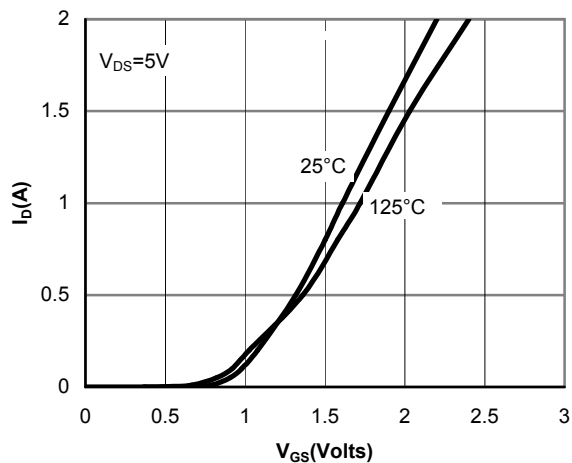


Figure 2: Transfer Characteristics

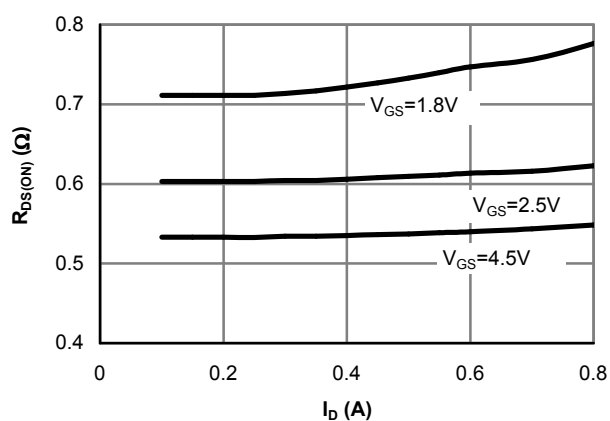


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

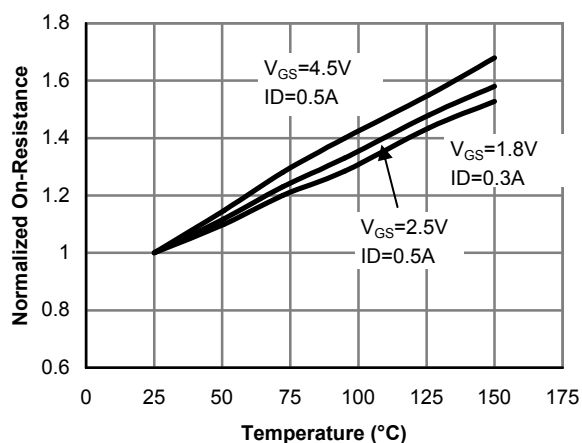


Figure 4: On-Resistance vs. Junction Temperature

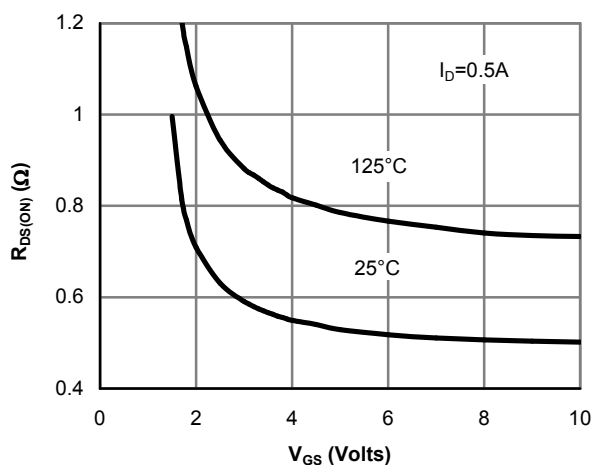


Figure 5: On-Resistance vs. Gate-Source Voltage

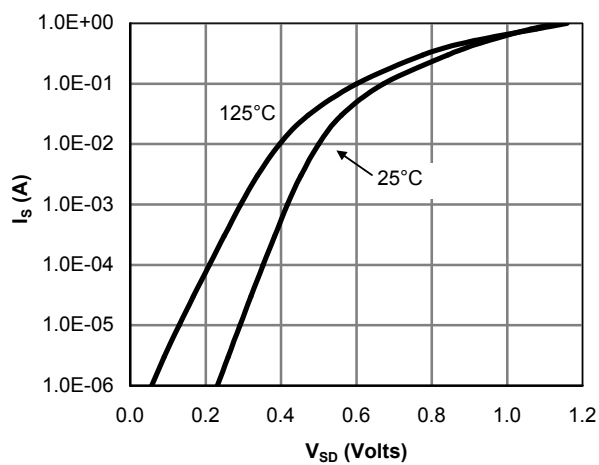


Figure 6: Body-Diode Characteristics

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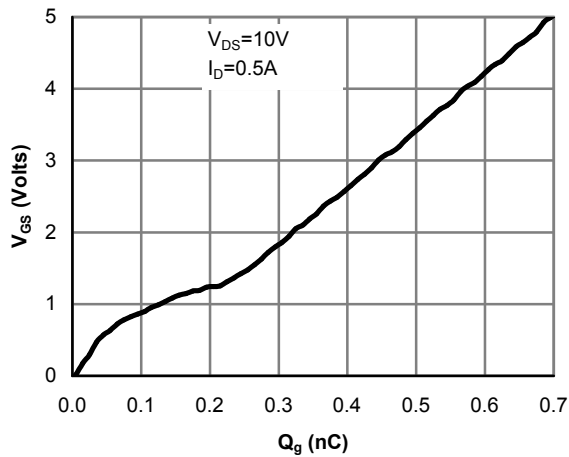


Figure 7: Gate-Charge Characteristics

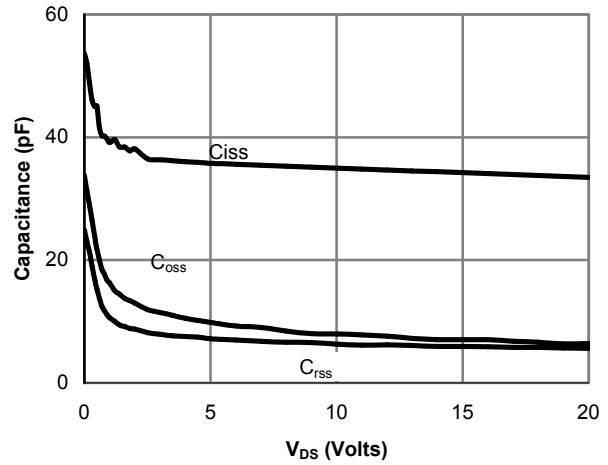


Figure 8: Capacitance Characteristics

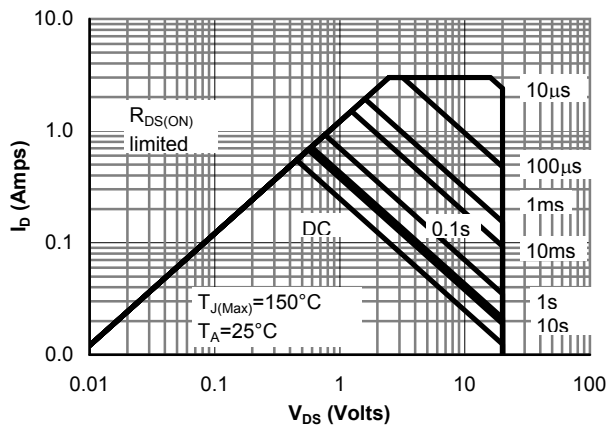


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

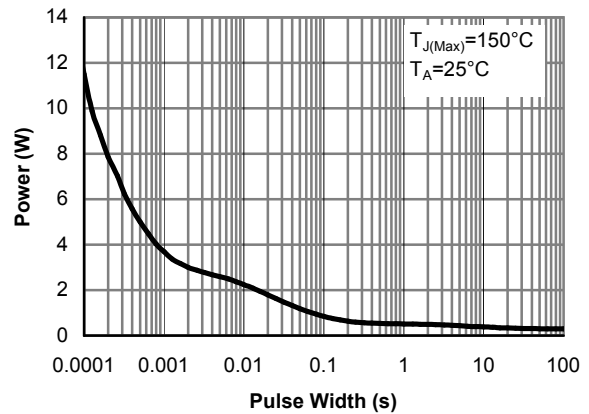


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

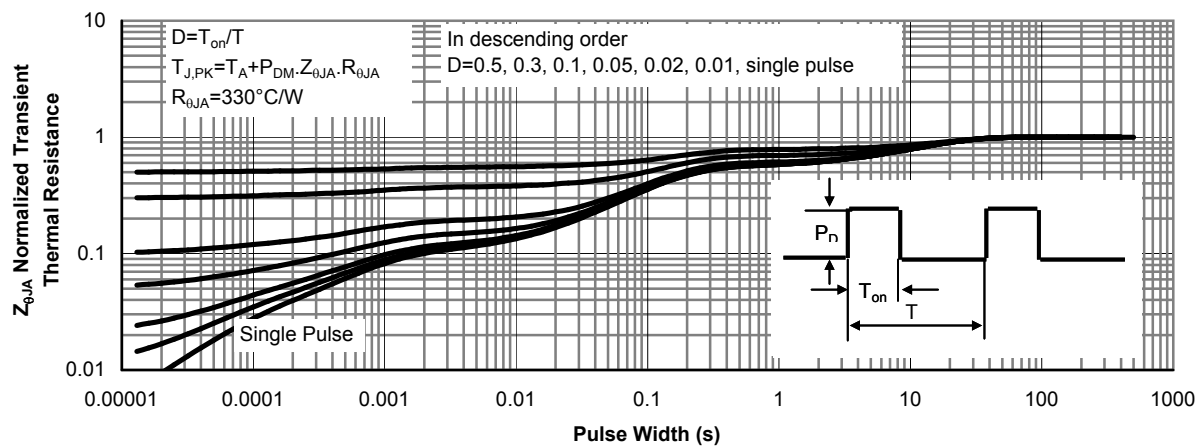


Figure 11: Normalized Maximum Transient Thermal Impedance

P-Channel Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =-250μA, V _{GS} =0V	-20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-20V, V _{GS} =0V T _J =55°C			1 5	μA
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±4.5V			±1	μA
		V _{DS} =0V, V _{GS} =±8V			±10	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} I _D =-250μA	-1	-0.6	-0.45	
I _{D(ON)}	On state drain current	V _{GS} =-4.5V, V _{DS} =-5V	-1			A
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-4.5V, I _D =-0.5A T _J =125°C		0.65 0.9	0.8 1.1	Ω
		V _{GS} =-2.5V, I _D =-0.5A		0.85	1	Ω
		V _{GS} =-1.8V, I _D =-0.3A		1.05	1.3	Ω
g _{FS}	Forward Transconductance	V _{DS} =-5V, I _D =-0.51A		0.9		S
V _{SD}	Diode Forward Voltage	I _S =-0.1A, V _{GS} =0V		-0.66	-1	V
I _S	Maximum Body-Diode Continuous Current				-0.5	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-10V, f=1MHz		72	100	pF
C _{oss}	Output Capacitance			17		pF
C _{rss}	Reverse Transfer Capacitance			9		pF
SWITCHING PARAMETERS						
t _{D(on)}	Turn-On DelayTime	V _{GS} =-4.5V, V _{DS} =-10V, R _L =50Ω, R _{GEN} =3Ω		60.5		ns
t _r	Turn-On Rise Time			150		ns
t _{D(off)}	Turn-Off DelayTime			612		ns
t _f	Turn-Off Fall Time			436		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-0.5A, dI/dt=100A/μs		27	35	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =-0.5A, dI/dt=100A/μs		8.3		nC

A: The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C: The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient.

D: The static characteristics in Figures 1 to 6,12,14 are obtained using <300 μs pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The SOA curve provides a single pulse rating.

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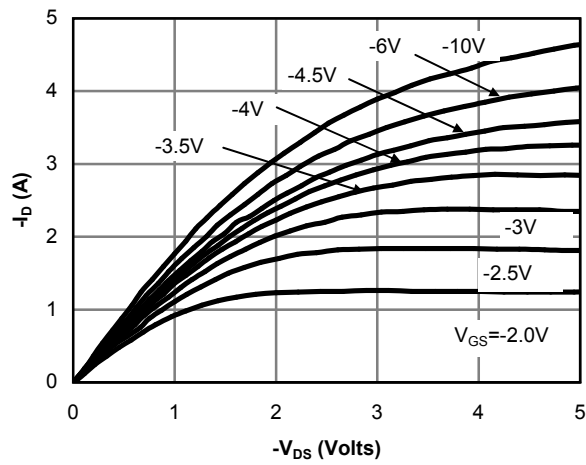


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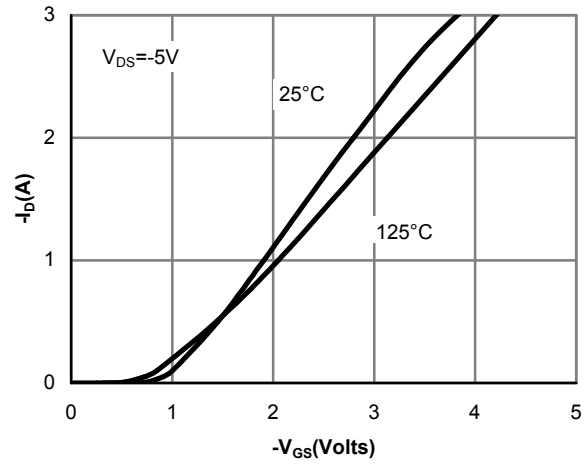


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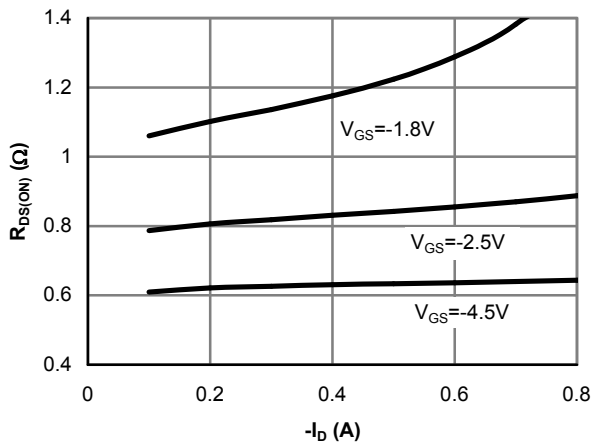


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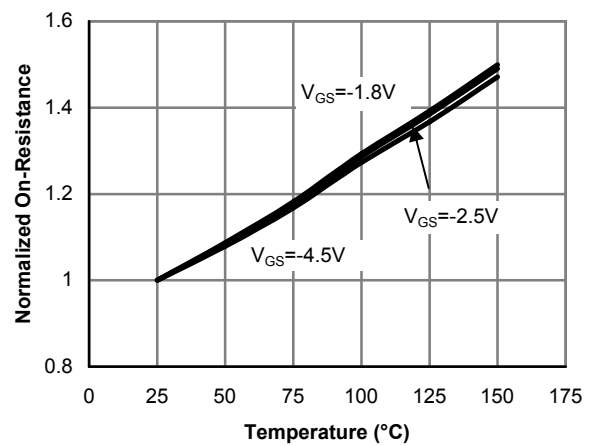


Figure 4: On-Resistance vs. Junction Temperature

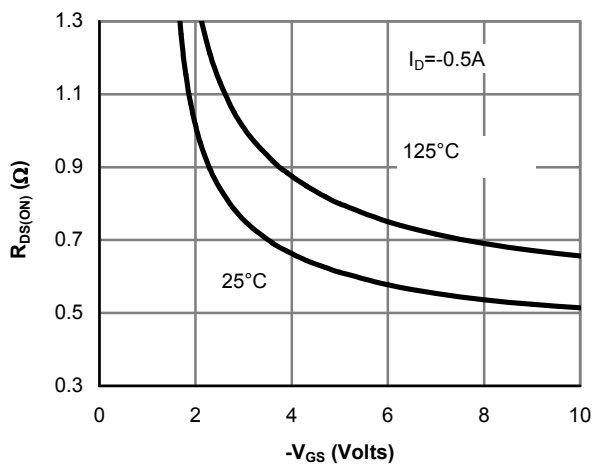


Figure 5: On-Resistance vs. Gate-Source Voltage

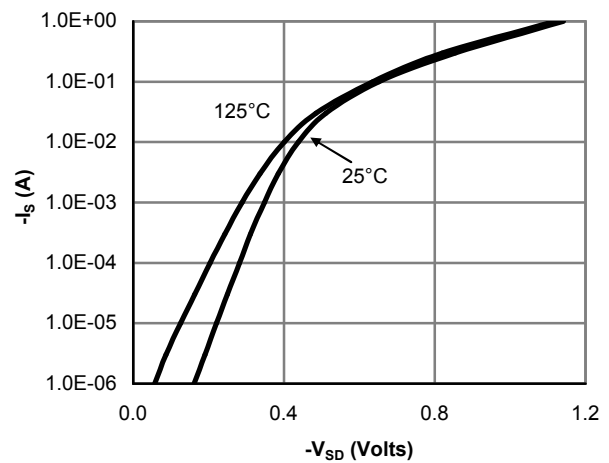


Figure 6: Body-Diode Characteristics

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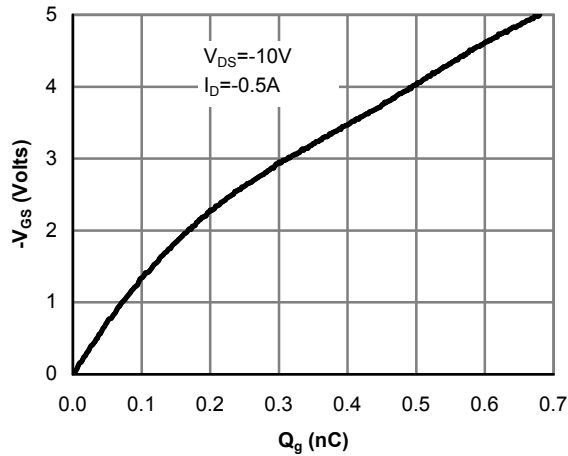


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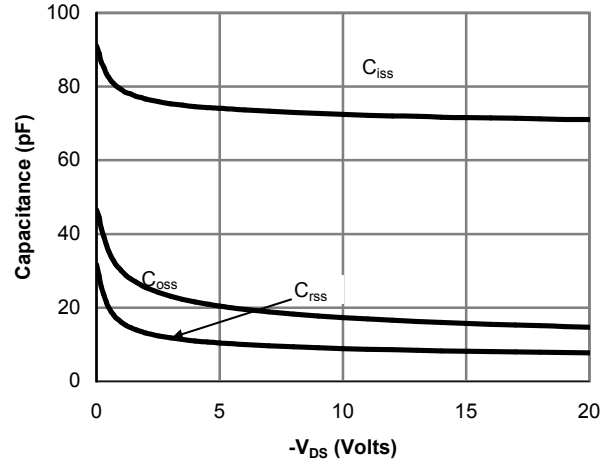


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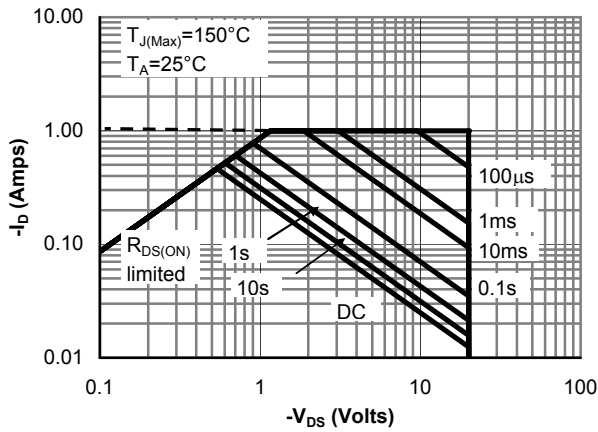


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

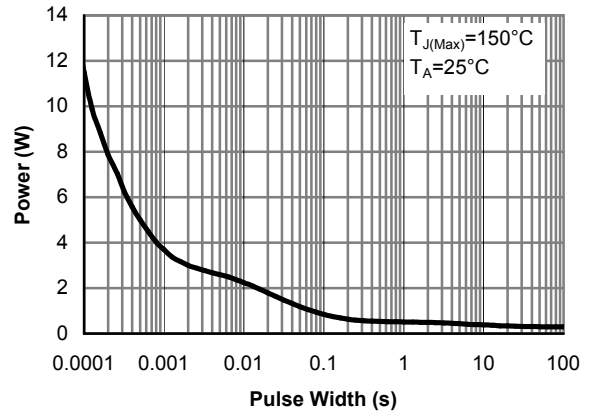


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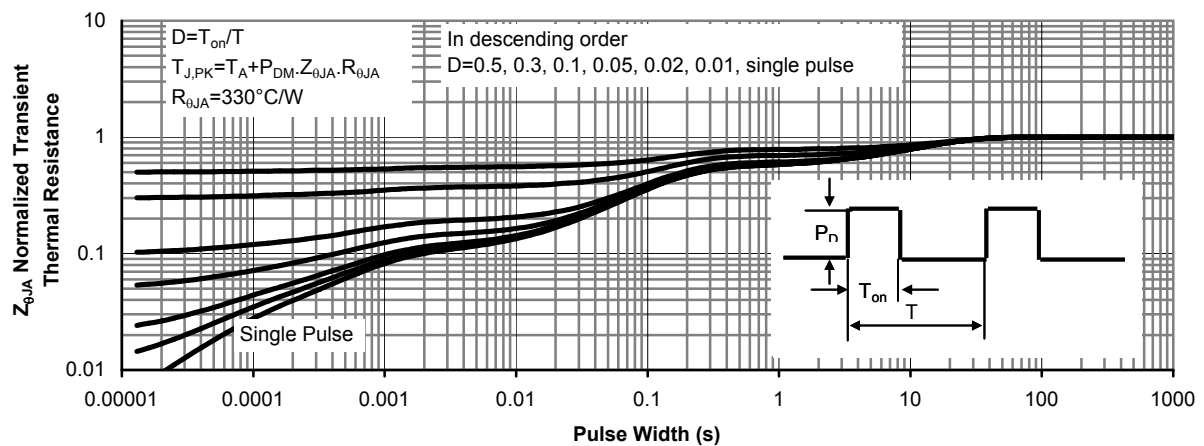
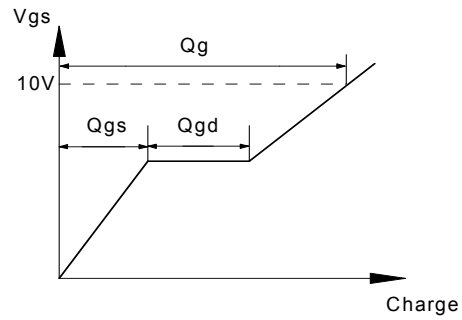
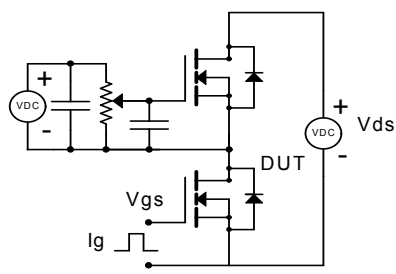
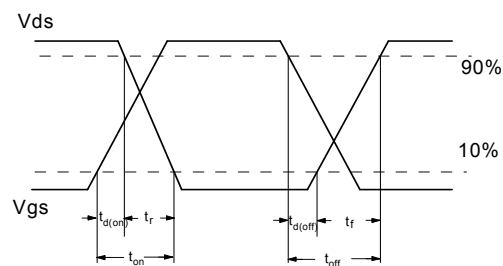
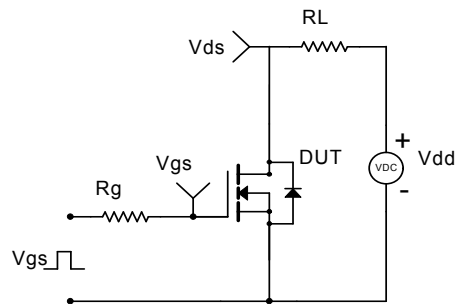


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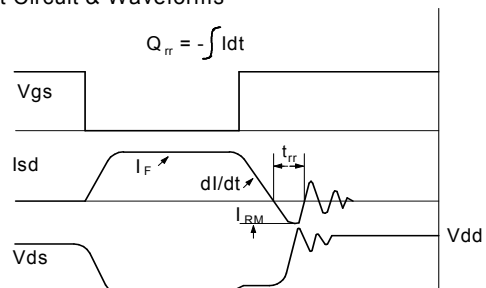
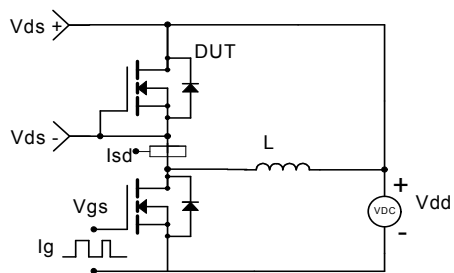
Gate Charge Test Circuit & Waveform



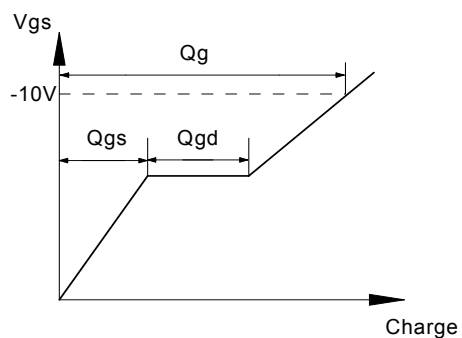
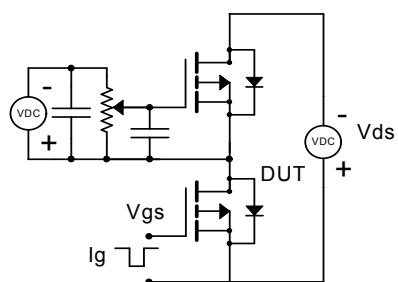
Resistive Switching Test Circuit & Waveforms



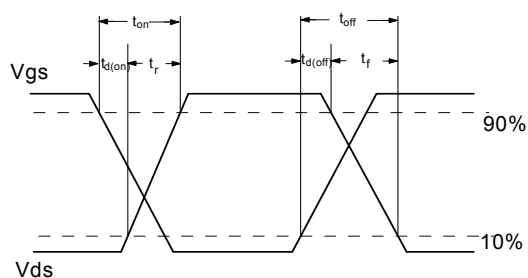
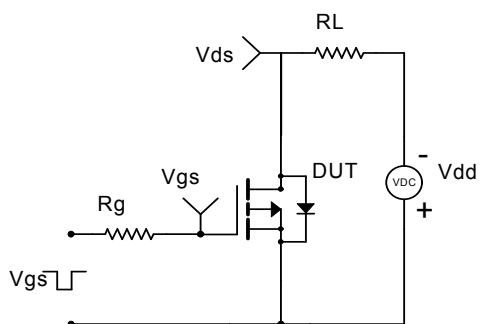
Diode Recovery Test Circuit & Waveforms



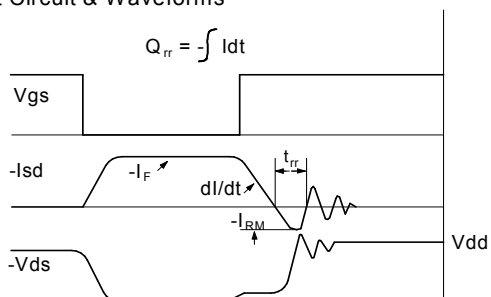
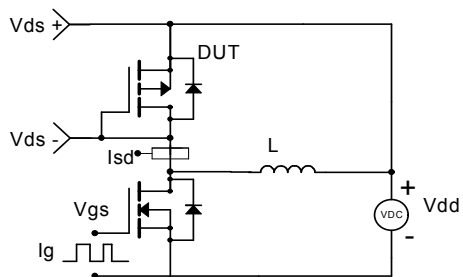
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms





**Стандарт
Электрон
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

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